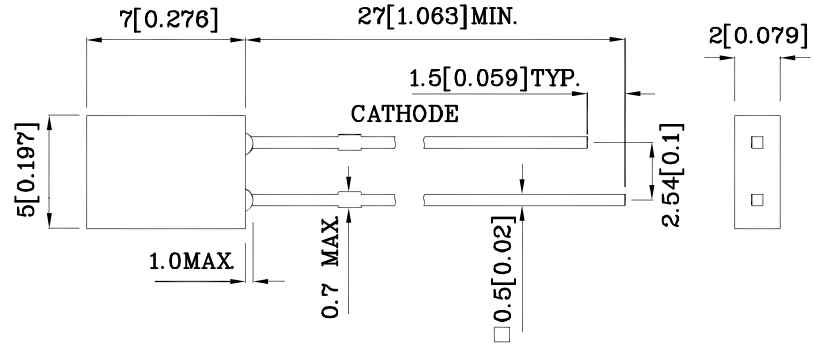


Features

- Radial / Through hole package
- Reliable & robust
- Low power consumption
- Available on tape and reel
- RoHS Compliant



Package Schematics

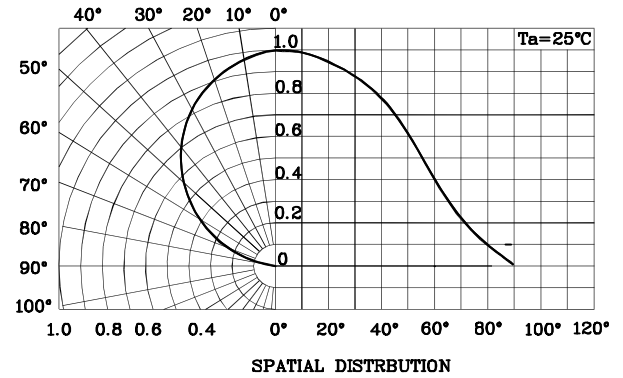
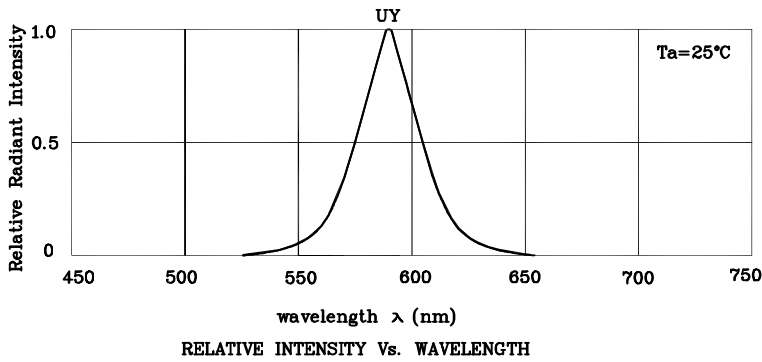


- Notes:
1. All dimensions are in millimeters (inches).
 2. Tolerance is $\pm 0.25(0.01)$ " unless otherwise noted.
 3. Specifications are subject to change without notice.

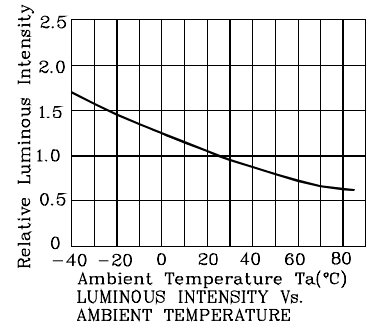
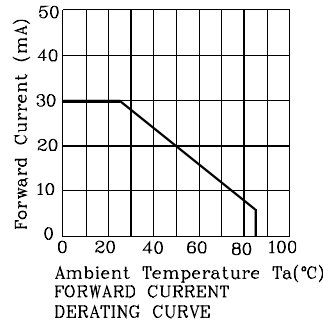
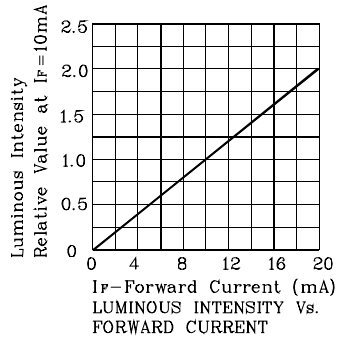
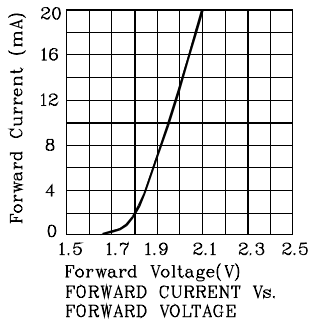
Absolute Maximum Ratings ($T_A=25^\circ\text{C}$)		UY (GaAsP/GaP)	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	140	mA
Power Dissipation	P_D	75	mW
Operating Temperature	T_A	-40 ~ +85	°C
Storage Temperature	T_{stg}	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds		
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds		

Operating Characteristics ($T_A=25^\circ\text{C}$)		UY (GaAsP/GaP)	Unit
Forward Voltage (Typ.) ($I_F=10\text{mA}$)	V_F	1.95	V
Forward Voltage (Max.) ($I_F=10\text{mA}$)	V_F	2.5	V
Reverse Current (Max.) ($V_R=5\text{V}$)	I_R	10	μA
Wavelength of Peak Emission (Typ.) ($I_F=10\text{mA}$)	λ_P	590	nm
Wavelength of Dominant Emission (Typ.) ($I_F=10\text{mA}$)	λ_D	588	nm
Spectral Line Full Width At Half-Maximum (Typ.) ($I_F=10\text{mA}$)	$\Delta\lambda$	35	nm
Capacitance (Typ.) ($V_F=0\text{V}$, $f=1\text{MHz}$)	C	20	pF

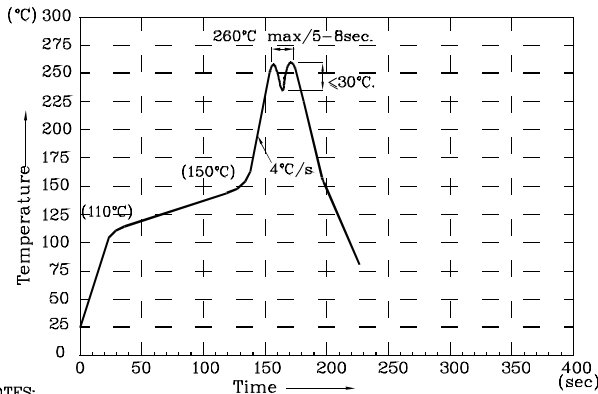
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity ($I_F=10\text{mA}$) mcd		Wavelength nm λ_P	Viewing Angle 2 θ 1/2
				min.	typ.		
XSUY18D	Yellow	GaAsP/GaP	Yellow Diffused	1.2	3.8	590	110°



❖ UY



Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. During wave soldering, the PCB top-surface temperature should be kept below 105°C.
5. No more than once.

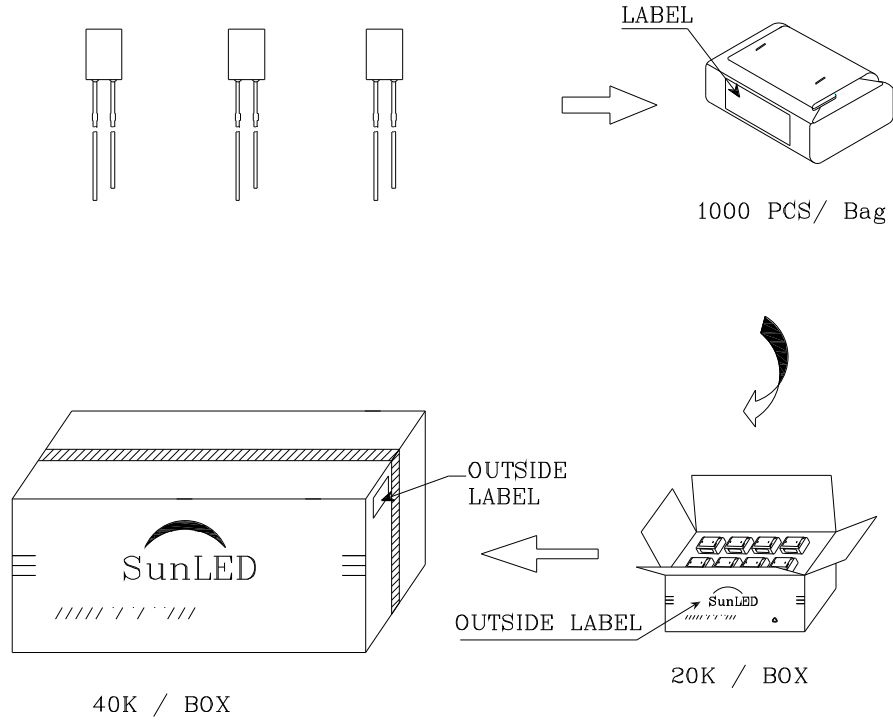
Remarks:



If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity / Luminous Flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS



	<table border="1"> <tr><td>Q.C.</td></tr> <tr><td>Q C</td></tr> <tr><td>XX XX XX</td></tr> <tr><td>PASSED</td></tr> </table>	Q.C.	Q C	XX XX XX	PASSED
Q.C.					
Q C					
XX XX XX					
PASSED					
P/NO : XSxx18x	<table border="1"> <tr><td>FQC</td></tr> </table>	FQC			
FQC					
QTY : 1000 pcs	CODE: XXX				
S/N : XX					
LOT NO:					
 XXXXXXXXXXXXXXXXXXXXXXXXXX	RoHS Compliant				